

LOW DROP OR-ing POWER SCHOTTKY RECTIFIER

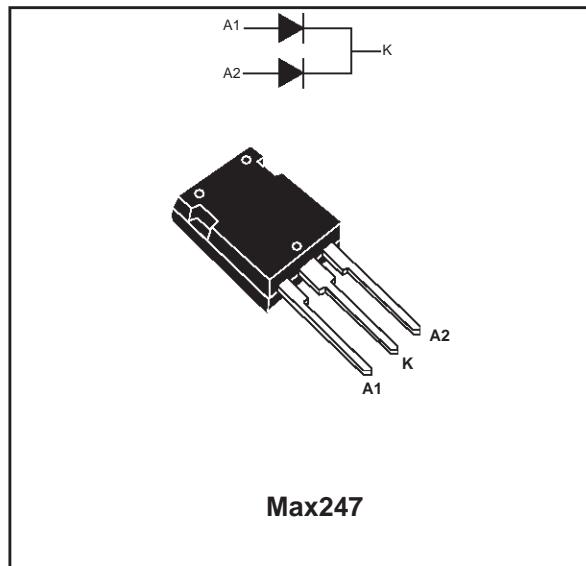
PRELIMINARY DATASHEET

MAIN PRODUCT CHARACTERISTICS

| | |
|-------------------|----------|
| $I_{F(AV)}$ | 2 x 40 A |
| V_{RRM} | 15 V |
| $T_j(\text{max})$ | 125 °C |
| $V_F(\text{max})$ | 0.33 V |

FEATURES AND BENEFITS

- Max247 PACKAGE, DUAL DIODE CONSTRUCTION, 2 x 40A
- 15V BLOCKING VOLTAGE SUITABLE FOR 5V AND 12V OR-ing
- EXTREMELY LOW VOLTAGE VOLTAGE DROP: 0.33V @ 100°C
- OPERATING JUNCTION TEMPERATURE: 125°C



DESCRIPTION

The STPS80L15CY uses proprietary barrier technology to optimize forward voltage drop for OR-ing functions in n-1 fault tolerant Switch Mode Power Supplies.

ABSOLUTE RATINGS (limiting values, per diode)

| Symbol | Parameter | | | Value | Unit |
|--------------|--|--------------------------------------|-----------------------------|---------------|------------------|
| V_{RRM} | Repetitive peak reverse voltage | | | 15 | V |
| $I_{F(RMS)}$ | RMS forward current | | | 50 | A |
| $I_{F(AV)}$ | Average forward current | $T_c = 110^\circ\text{C}$ | Per diode $\delta = 0.5$ | 40 80 | A |
| I_{FSM} | Surge non repetitive forward current | tp = 10 ms sinusoidal | | 400 | A |
| I_{IRR} | Repetitive peak reverse current | tp = 2 μs F = 1kHz square | | 2 | A |
| T_{stg} | Storage temperature range | | | - 65 to + 150 | °C |
| T_j | Maximum operating junction temperature | | | 125 | °C |
| dV/dt | Critical rate of rise of reverse voltage | | | 10000 | V/ μs |

STPS80L15CY

THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|-----------------------|------------------|-----------|------|
| R _{th} (j-c) | Junction to case | Per diode | 0.7 |
| | | Total | 0.5 |
| R _{th} (c) | | Coupling | 0.3 |

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{\text{th(j-c)}}(\text{Per diode}) + P(\text{diode 2}) \times R_{\text{th(c)}}$$

STATIC ELECTRICAL CHARACTERISTICS (per diode)

| Symbol | Parameter | Tests conditions | | Min. | Typ. | Max. | Unit |
|------------------|-------------------------|------------------------|-----------------------|------|------|------|------|
| I _R * | Reverse leakage current | T _j = 25°C | V _R = 5V | | | 4 | mA |
| | | T _j = 100°C | | | 280 | 400 | |
| | | T _j = 25°C | V _R = 12V | | | 11 | A |
| | | T _j = 100°C | | | 0.44 | 1.1 | |
| | | T _j = 25°C | V _R = 15V | | | 16 | mA |
| | | T _j = 100°C | | | 0.53 | 1.3 | A |
| V _F * | Forward voltage drop | T _j = 25°C | I _F = 40 A | | | 0.42 | V |
| | | T _j = 100°C | I _F = 40 A | | 0.30 | 0.33 | |
| | | T _j = 25°C | I _F = 80 A | | | 0.55 | |
| | | T _j = 100°C | I _F = 80 A | | 0.40 | 0.46 | |

Pulse test : * tp = 380 μs, δ < 2%

To evaluate the maximum conduction losses use the following equation :

$$P = 0.20 \times I_{F(\text{AV})} + 0.0032 \times I_{F(\text{RMS})}^2$$

Fig. 1: Average forward power dissipation versus average forward current (per diode).

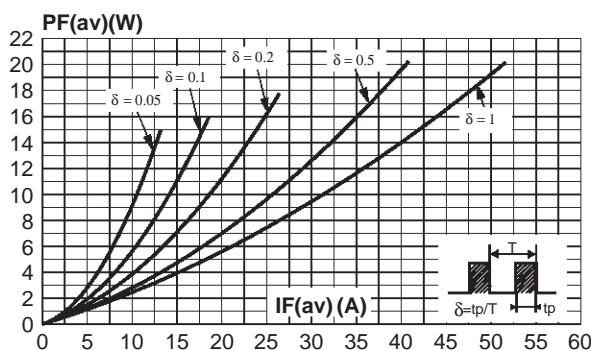


Fig. 2: Average forward current versus ambient temperature ($\delta=0.5$, per diode).

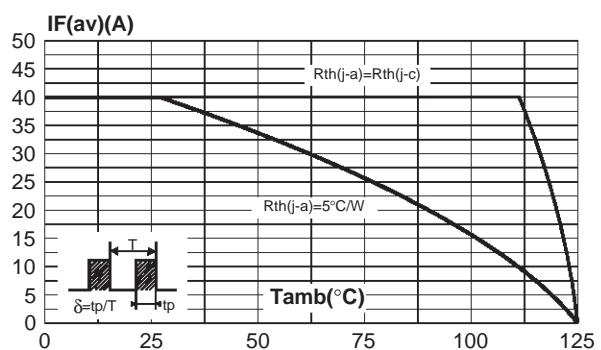


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values, per diode).

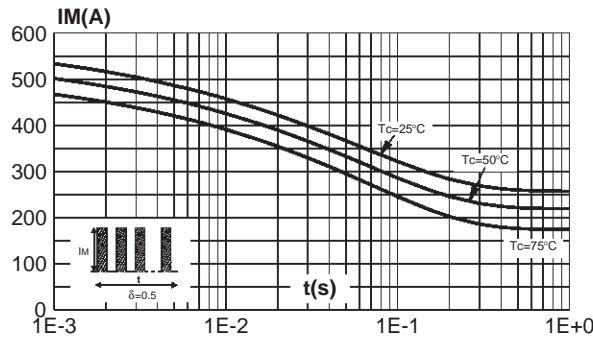


Fig. 4: Relative variation of thermal impedance junction to case versus pulse (per diode).

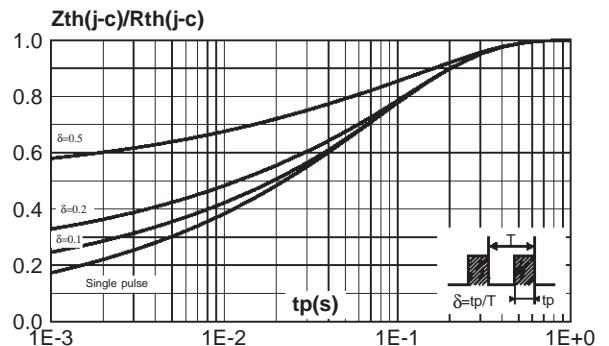


Fig. 5: Reverse leakage current versus reverse voltage applied (typical values, per diode).

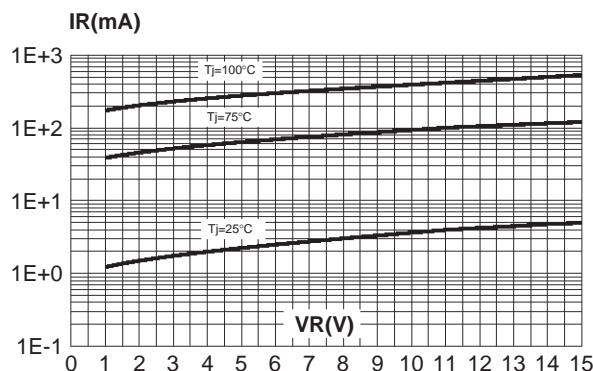


Fig. 6: Junction capacitance versus reverse voltage applied (typical values, per diode).

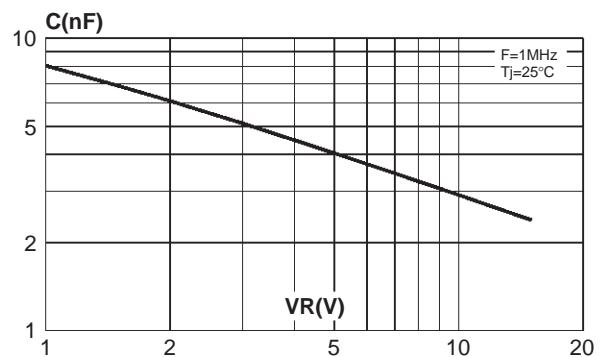
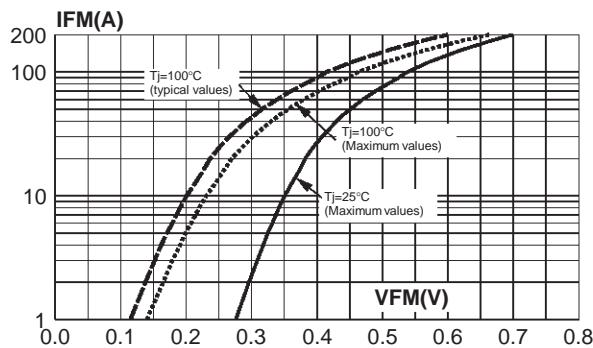


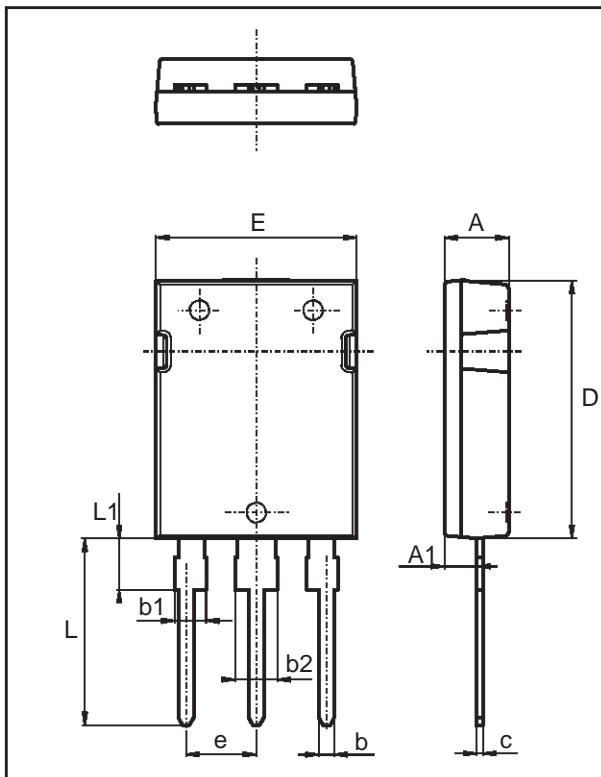
Fig. 7: Forward voltage drop versus forward current (per diode).



STPS80L15CY

PACKAGE MECHANICAL DATA

Max247



| REF. | DIMENSIONS | | | |
|------|-------------|-------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 4.70 | 5.30 | 0.185 | 0.209 |
| A1 | 2.20 | 2.60 | 0.087 | 0.102 |
| b | 1.00 | 1.40 | 0.038 | 0.055 |
| b1 | 2.00 | 2.40 | 0.079 | 0.094 |
| b2 | 3.00 | 3.40 | 0.118 | 0.133 |
| c | 0.40 | 0.80 | 0.016 | 0.031 |
| D | 19.70 | 10.30 | 0.776 | 0.799 |
| e | 5.35 | 5.55 | 0.211 | 0.219 |
| E | 15.30 | 15.90 | 0.602 | 0.626 |
| L | 14.20 | 15.20 | 0.559 | 0.598 |
| L1 | 3.70 | 4.30 | 0.146 | 0.169 |

| Ordering type | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|-------------|---------|--------|----------|---------------|
| STPS80L15CY | STPS80L15CY | Max247 | 4.4g | 30 | Tube |

- Cooling method: by conduction (C)
- Epoxy meets UL94,V0

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